PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Scott D. Clark	05/22/2013
Ashish A. More	05/29/2013
Anil Pothireddy	05/29/2013
Sudheendra K. Srivathsa	05/29/2013
Brian T. Vanderpool	05/20/2013

RECEIVING PARTY DATA

Name:	International Business Machines Corporation
Street Address:	New Orchard Road
City:	Armonk
State/Country:	NEW YORK
Postal Code:	10504

PROPERTY NUMBERS Total: 1

	Property Type	Number
Application	n Number:	13909686

CORRESPONDENCE DATA

Fax Number: 5072532382

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Email: rocdrctr@us.ibm.com

Correspondent Name: Penny L. Lowry

Address Line 1: 3605 Highway 52 North

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ATTORNEY DOCKET NUMBER:	ROC920130045US1	
NAME OF SUBMITTER:	Penny L. Lowry	
Signature:	/Penny L. Lowry/	

502371493 REEL: 030543 FRAME: 0742

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Date:	06/04/2013	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
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DECLARATION (37 C.F.R. 1.63) FOR UTILITY PATENT APPLICATION USING AN APPLICATION DATA SHEET (37 C.F.R. 1.76) AND ASSIGNMENT

Title of Invention: INTEGRATED LINK-BASED DATA RECORDER FOR SEMICONDUCTOR CHIP

This declaration is directed to the attached application, or (if following box is checked):
[] United States application or PCT international application numberfiled on
The above-identified application was made or authorized to be made by me.
I believe that I am the original inventor or an original joint inventor of a claimed invention in the

application.

I have reviewed and understand the contents of the application, including the claims.

As a below named and undersigned inventor, I hereby declare that:

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR Section 1.56.

Whereas, I ("ASSIGNOR") have made certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified patent application and further identified by the IBM Docket Number provided above in the header of this document;

Whereas, International Business Machines Corporation (herein referred to as the "ASSIGNEE"), a corporation of New York having a place of business at Armonk, New York, desires to acquire, and I desire to grant to the ASSIGNEE, my entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, I hereby sell or have sold, assign or have assigned, and otherwise transfer or have transferred to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, I hereby authorize and request the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to the ASSIGNEE, its successors, legal representatives, and assigns, my entire worldwide right, title, and interest in and to the same to be held and enjoyed by the ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by me had this Assignment not been made; and I agree to execute any and all documents and instruments and

I acknowledge my prior and ongoing obligations to sell, assign, and transfer my rights under this Assignment to the ASSIGNEE and am unaware of any reason why I may not have the full and unencumbered right to sell, assign, and transfer my rights hereby sold, assigned, and transferred, and have not executed, and will not execute, any document or instrument in conflict herewith. I also hereby grant the ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment. This Assignment is governed by the substantive laws of the State of New York, and any disputes will be resolved in a New York state court or federal court sited in New York.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

(1) Legal Name of Inventor: Scott D. Clark

1 40 Of 1	r-/	1-
Signature: Martin Mark	Date: 5/22	//3
(2) Legal Name of Inventor: Ashish A. More		
Signature:	Date:	
(3) Legal Name of Inventor: Anil Pothireddy		
Signature:	Date:	
(4) Legal Name of Inventor: Sudheendra K. Srivathsa		
Signature:	Date:	18 *** *
(5) Legal Name of Inventor: Brian T. Vanderpool		
Signature: BIVM	Data: 5/20/	13

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(1) Legal Name of Invento	r: Scott D. Clark	
Signature:		Date:
(2) Legal Name of Invento		
Signature: <u>M</u>		Date: 05/29/201
(3) Legal Name of Invento	r: Anii Pothireddy	
Signature:		Date
(4) Legal Name of Invento	r: Sudheendra K. Srivathsa	
Signature:		Date:
(5) Legal Name of Invento	r: Brisa T. Vanderpoul	
Sionature		Pare

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(1) Legal Name of Inventor: Scott D. Clark

· · · · · ·	
Signature:	Date:
(2) Legal Name of Inventor: Ashish A. More	
Signature:	Date:
(3) Legal Name of Inventor: Anil Pothireddy	05 30 000
Signature:	
(4) Legal Name of Inventor: Sudheendra K. Srivathsa	
Signature:	Date:
(5) Legal Name of Inventor: Brian T. Vanderpool	
Cionatana	Date

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